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approved for entry /tmd/

2/13/08



BOUNDARY ACOUSTIC WAVE DEVICE

BACKGROUND OF THE INVENTION

1. Field of the Invention

[0001] The present invention relates to a boundary acoustic wave device using a Stoneley wave, and more particularly, to a boundary acoustic wave device using a Stoneley wave and including electrodes that are disposed at a boundary between a piezoelectric substance and a dielectric substance.

2. Description of the Related Art

[0002] Heretofore, various surface acoustic wave devices have been used for RF and IF filters in mobile phones, resonators in VCOs, VIF filters in televisions, and other devices. Surface acoustic wave devices use a surface acoustic wave, such as a Rayleigh wave or a first leaky wave, which propagates along a surface of a medium.

[0003] Since the acoustic wave propagating along a surface of a medium, a surface acoustic wave is sensitive to changes in the surface condition of the medium. Accordingly, in order to protect a surface of a medium along which a surface acoustic wave propagates, a surface acoustic wave element is often hermetically sealed in a package in which a cavity portion is provided so as to face the wave-propagating surface. Since the package having a

cavity portion as described above is used, the cost of the surface acoustic wave device is increased. In addition, since the size of the package is much larger than that of the surface acoustic wave element, the size of the surface acoustic wave device is increased.

[0004] On the other hand, among acoustic waves, in addition to the above-described surface acoustic waves, a boundary acoustic wave propagates along a boundary between solid substances.

[0005] For example, in "Piezoelectric Acoustic Boundary Waves Propagating Along the Interface Between SiO_2 and LiTaO_3 " IEEE Trans. Sonics and Ultrasonics, VOL. SU-25, No. 6, 1978 IEEE (non-patent document 1), a boundary acoustic wave device is disclosed in which an IDT is disposed on a 126° rotated Y plate X-propagation LiTaO_3 substrate and a SiO_2 film having a predetermined thickness is disposed on the LiTaO_3 substrate and the IDT. In non-patent document 1, an SV+P type boundary acoustic wave, which is a so-called Stoneley wave, is propagated. In non-patent document 1, when the thickness of the above SiO_2 film is set to 1.0λ (λ indicates the wavelength of a boundary acoustic wave), an electromechanical coefficient of 2% is obtained.

[0006] The boundary acoustic wave propagates in the state in which energy is concentrated on a boundary portion between solid substrates. Hence, since energy is not substantially present on the bottom surface of the above LiTaO_3 substrate and the surface of the SiO_2 film, the properties are not changed by changes in

surface conditions of the substrate and the thin film.

[0007] Accordingly, a package having a cavity portion is not required, and hence the size of the boundary acoustic wave device is reduced.

[0008] In addition, in "Piezoelectric Boundary Wave in a Substrate with a Layered Structure" authored by Chujo, Yamanouchi, and Shibayama, Research Institute of Electrical Communication, US80-4, 1980 (non-patent document 2), a boundary acoustic wave called a Stoneley wave is disclosed which propagates in the structure in which a SiO_2 film is disposed on a 128° rotated Y plate X-propagation LiNbO_3 substrate. According to the analysis of the non-patent document 2, it is shown that when the SiO_2 is in its natural state, since the displacement is not concentrated on the boundary between the SiO_2 layer and the LiNbO_3 substrate, a boundary acoustic wave is not generated, and that when the Lamé constant indicating the elasticity of SiO_2 is changed from an inherent value of $0.3119 \times 10^{11} \text{ N/m}^2$ to $0.4679 \times 10^{11} \text{ N/m}^2$, the displacement is concentrated on the boundary, such that a boundary acoustic wave is generated. In addition, according to the experimental result of the non-patent document 2, it has also been disclosed that even when conditions for forming the SiO_2 layer are changed, a SiO_2 film cannot be formed in which a boundary acoustic wave propagates.

[0009] In a boundary acoustic wave device, a large electromechanical coefficient, a small propagation loss, a small power flow angle, and a small temperature coefficient of

frequency have been required. The loss caused by the propagation of a boundary acoustic wave, that is, the propagation loss, may degrade the insertion loss of a boundary acoustic wave filter or may also degrade the resonant resistance or the impedance ratio of a boundary acoustic wave resonator, the impedance ratio being a ratio between the impedance at a resonant frequency and that at an antiresonant frequency. Hence, the propagation loss is preferably decreased to as small as possible.

[0010] The power flow angle is an angle indicating the difference between the direction of the phase velocity of a boundary acoustic wave and the direction of the group velocity of energy thereof. When the power flow angle is large, it is necessary to obliquely dispose an IDT in conformity with the power flow angle. Hence, the design of the electrodes is complicated. In addition, a loss caused by a deviation in the angle is likely to be generated.

[0011] Furthermore, when an operating frequency of a boundary acoustic wave device is changed by the temperature, practical pass band and stop band are decreased in a boundary acoustic wave filter. With a resonator, when an oscillation circuit is formed, the above-described change in operating frequency caused by the temperature results in abnormal oscillation. Hence, the change in frequency per degree centigrade, which is TCF, is preferably decreased to as small as possible.

[0012] For example, when reflectors are disposed along a propagation direction and outside a region in which a

transmitting IDT and a receiving IDT are provided, which transmits and receives a boundary acoustic wave, respectively, a low-loss resonator type filter can be formed. The band width of this resonator type filter depends on the electromechanical coefficient of a boundary acoustic wave. When the electromechanical coefficient k^2 is large, a broadband filter is obtained, and when the electromechanical coefficient k^2 is small, a narrowband filter is obtained. Thus, the electromechanical coefficient k^2 of a boundary acoustic wave used for a boundary acoustic wave device must be appropriately determined in accordance with its application. When an RF filter for mobile phones is formed, the electromechanical coefficient k^2 is required to be at least 5%.

[0013] However, in the boundary acoustic wave device using a Stoneley wave, which is disclosed in non-patent document 1, the electromechanical coefficient k^2 is small, such as 2%.

[0014] In addition, in the $\text{SiO}_2/\text{LiNbO}_3$ structure disclosed in the non-patent document 2, a LiNbO_3 substrate having large piezoelectric properties is used. Hence, compared to the boundary acoustic wave device described in the non-patent document 1, a larger electromechanical coefficient k^2 can be obtained. However, it is difficult to form a SiO_2 film such that a boundary acoustic wave propagates, and the non-patent document 2 discloses no measurement results of a Stoneley wave after actually forming the SiO_2 film.

SUMMARY OF THE INVENTION

[0015] To overcome the problems described above, preferred embodiments of the present invention provide a boundary acoustic wave device using a Stoneley wave which has a sufficiently large electromechanical coefficient, small propagation loss, small power flow angle, and a small temperature coefficient of frequency, and which can be manufactured by a simple method.

[0016] In accordance with a first preferred embodiment of the present invention, a boundary acoustic wave device using a Stoneley wave includes a piezoelectric substance, a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes provided at a boundary between the piezoelectric substance and the dielectric substance. In the boundary acoustic wave device according to this preferred embodiment, the thickness of the electrodes is determined such that the acoustic velocity of the Stoneley wave is less than that of a slow transverse wave propagating through the dielectric substance and that of a slow transverse wave propagating through the piezoelectric substance.

[0017] In accordance with a second preferred embodiment of the present invention, a boundary acoustic wave device using a Stoneley wave includes a piezoelectric substance, a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes provided at a boundary between the piezoelectric substance and the dielectric substance. In the boundary acoustic wave device according to this preferred embodiment, the duty ratio of strips defining the electrodes is determined such that

the acoustic velocity of the Stoneley wave is less than that of a slow transverse wave propagating through the dielectric substance and that of a slow transverse wave propagating through the piezoelectric substance.

[0018] In accordance with a third preferred embodiment of the present invention, a boundary acoustic wave device using a Stoneley wave includes a piezoelectric substance primarily including LiNbO_3 , a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes provided at a boundary between the piezoelectric substance and the dielectric substance. In the boundary acoustic wave device according to this preferred embodiment, Euler angles (ϕ , θ , ψ) of the piezoelectric substance primarily including LiNbO_3 are in the respective ranges shown in the following Table 1, and a Stoneley wave having an acoustic velocity of 3,757 m/sec or less is used.

Table 1

ϕ (°)	θ (°)	ψ (°)
30	90	225
30	270	135
30	270	315
90	90	135
90	90	315
90	270	45
90	270	225
150	90	45
150	90	225
150	270	135
150	270	315
210	90	135
210	90	315
210	270	45
210	270	225
270	90	45
270	90	225
270	270	135
270	270	315
330	90	135
330	90	315
330	270	45
330	270	225

[0019] In the second and the third preferred embodiments of the present invention, the thickness of the electrodes is preferably determined such that the acoustic velocity of the

Stoneley wave is less than that of the slow transverse wave propagating through the dielectric substance and that of the slow transverse wave propagating through the piezoelectric substance.

[0020] In the boundary acoustic wave device according to the third preferred embodiment of the present Invention, the duty ratio of strips forming the electrodes is preferably determined such that the acoustic velocity of the Stoneley wave is less than that of a slow transverse wave propagating through the dielectric substance and that of a slow transverse wave propagating through the piezoelectric substance.

[0021] In accordance with a fourth preferred embodiment of the present invention, a boundary acoustic wave device using a Stoneley wave includes a piezoelectric substance primarily including LiNbO_3 , a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes provided at a boundary between the piezoelectric substance and the dielectric substance. In the boundary acoustic wave device described above, when the density of the electrodes, the thickness thereof, and the wavelength of the Stoneley wave are represented by ρ (kg/m^3), H (λ) and λ , respectively, $H > 1/[1/(3 \times 10^7 \times \rho^{-2.22} + 0.017) - 0.4]$ is maintained.

[0022] In the fourth preferred embodiment of the present invention, the density ρ of the electrodes is preferably set to $4,711 \text{ kg/m}^3$ or more.

[0023] In accordance with a fifth preferred embodiment of the present invention, a boundary acoustic wave device using a

Stoneley wave includes a piezoelectric substance primarily including LiNbO_3 , a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes provided at a boundary between the piezoelectric substance and the dielectric substance. In the boundary acoustic wave device described above, when the density of the electrodes, the thickness thereof, and the wavelength of the Stoneley wave are represented by ρ (kg/m^3), H (λ), and λ , respectively, $H > 0.03\lambda$ and $\rho > 2,699 \text{ kg/m}^3$ is maintained.

[0024] In the boundary acoustic wave device according to one of the first to the fifth preferred embodiments of the present invention, preferably the electrodes primarily include an electrode layer including at least one material selected from the group consisting of Ag, Au, Cu, Fe, Mo, Ni, Ta, W, Ti, and Pt.

[0025] The boundary acoustic wave device according to the first preferred embodiment of the present invention includes a piezoelectric substance, a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes disposed at a boundary between the piezoelectric substance and the dielectric substance, and in the above-described boundary acoustic wave device, the thickness of the electrodes is preferably determined such that the acoustic velocity of a Stoneley wave is less than that of a slow transverse wave propagating through the dielectric substance and that of a slow transverse wave propagating through the piezoelectric substance.

[0026] In addition, the boundary acoustic wave device

according to the second preferred embodiment of the present invention includes a piezoelectric substance, a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes disposed at a boundary between the piezoelectric substance and the dielectric substance, and in the above-described boundary acoustic wave device, the duty ratio of strips forming the electrodes is determined such that the acoustic velocity of a Stoneley wave is less than that of a slow transverse wave propagating through the dielectric substance and that of a slow transverse wave propagating through the piezoelectric substance.

[0027] Hence, according to the first or second preferred of the present invention, since the thickness of the electrodes or the duty ratio of the strips thereof is determined as described above, a boundary acoustic wave device is provided in which the Stoneley wave propagates through the dielectric substance and the piezoelectric substance.

[0028] The boundary acoustic wave device according to the third preferred of the present invention includes a piezoelectric substance primarily including LiNbO_3 , a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes disposed at a boundary between the piezoelectric substance and the dielectric substance, and in the above-described boundary acoustic wave device, Euler angles (ϕ , θ , ψ) of the piezoelectric substance are in the respective ranges shown in Table 1, and a Stoneley wave having an acoustic velocity of

about 3,757 m/sec or less is preferably used. Accordingly, as apparent from examples to be described later, spurious responses are effectively suppressed, and the electromechanical coefficient k^2 of the Stoneley wave is increased.

[0029] In the boundary acoustic wave device according to the second or the third preferred embodiment of the present invention, when the thickness of the electrodes or the duty ratio is determined such that the acoustic velocity of the Stoneley wave is less than that of the slow transverse wave propagating through the dielectric substance and that of the slow transverse wave propagating through the piezoelectric substance, a boundary acoustic wave device is provided in which the Stoneley wave reliably propagates along the boundary between the dielectric substance and the piezoelectric substance.

[0030] The boundary acoustic wave device according to the fourth preferred embodiment of the present invention includes a piezoelectric substance primarily including LiNbO_3 , a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes provided at a boundary between the piezoelectric substance and the dielectric substance, and when the density of the electrodes, the thickness thereof, and the wavelength of the Stoneley wave are represented by ρ (kg/m^3), H (λ), and λ , respectively, $H > 1/[1/(3 \times 10^7 \times \rho^{-2.22} + 0.017) - 0.4]$ is maintained. Thus, a boundary acoustic wave device is provided which uses a Stoneley wave having an appropriate electromechanical coefficient k^2 . In particular, when the density ρ of the electrodes is 4,711

kg/m³ or more, the thickness of the electrodes at a propagation loss of 0 is decreased, and thus, the electrodes are easily formed.

[0031] The boundary acoustic wave device according to the fifth preferred embodiment of the present invention includes a piezoelectric substance primarily including LiNbO₃, a dielectric substance laminated on one surface of the piezoelectric substance, and electrodes provided at a boundary between the piezoelectric substance and the dielectric substance, and when the density of the electrodes, the thickness thereof, and the wavelength of the Stoneley wave are represented by ρ (kg/m³), H (λ), and λ , respectively, $H > 0.03 \lambda$ and $\rho > 2,699 \text{ kg/m}^3$ is maintained. Thus, a boundary acoustic wave device is provided which uses electrodes made of a material that is heavier than Al and in which the Stoneley wave propagates.

[0032] In various preferred embodiments of the present invention, when the electrodes are each primarily made of an electrode layer including at least one material selected from the group consisting of Ag, Au, Cu, Fe, Mo, Ni, Ta, W, Ti, and Pt, in accordance with the present invention, a boundary acoustic wave device using a Stoneley wave is provided. In addition, when at least one second electrode layer including a metal other than that forming the above-described electrode layer is further provided, by selecting a metal material forming the second electrode layer, the adhesion of the electrode with the dielectric substance or the piezoelectric substance is increased,

or the electric power resistance is enhanced.

[0033] Other features, elements, steps, characteristics and advantages of the present invention will become more apparent from the following detailed description of preferred embodiments of the present invention with reference to the attached drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

[0034] Fig. 1 is a front cross-sectional view showing a boundary acoustic wave device according to a preferred embodiment of the present invention.

[0035] Fig. 2 is a schematic plan view showing an IDT and reflectors, which are defined by electrodes, of a boundary acoustic wave device of a preferred embodiment according to the present invention.

[0036] Fig. 3 is a graph showing impedance-frequency characteristics of a boundary acoustic wave device A1 shown in Table 1 formed in Example 1.

[0037] Fig. 4 is a graph showing impedance-frequency characteristics of a boundary acoustic wave device A2 shown in Table 1 formed in Example 1.

[0038] Fig. 5 is a graph showing impedance-frequency characteristics of a boundary acoustic wave device A3 shown in Table 1 formed in Example 1.

[0039] Fig. 6 is a graph showing impedance-frequency characteristics of a boundary acoustic wave device A4 shown in Table 1 formed in Example 1.

[0040] Fig. 7 is a graph showing impedance-frequency characteristics of a boundary acoustic wave device A5 shown in Table 1 formed in Example 1.

[0041] Fig. 8 is a graph showing impedance-frequency characteristics of a boundary acoustic wave device A6 shown in Table 1 formed in Example 1.

[0042] Fig. 9 is a graph showing impedance-frequency characteristics of a boundary acoustic wave device A7 shown in Table 1 formed in Example 1.

[0043] Fig. 10 is a graph showing the relationship between an Euler angle ϕ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0044] Fig. 11 is a graph showing the relationship between an Euler angle ϕ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0045] Fig. 12 is a graph showing the relationship between an Euler angle ϕ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0046] Fig. 13 is a graph showing the relationship between an Euler angle ϕ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0047] Fig. 14 is a graph showing the relationship between an

Euler angle ϕ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0048] Fig. 15 is a graph showing the relationship between an Euler angle ϕ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0049] Fig. 16 is a graph showing the relationship between an Euler angle ϕ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0050] Fig. 17 is a graph showing the relationship between an Euler angle ϕ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0051] Fig. 18 is a graph showing the relationship between an Euler angle ϕ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0052] Fig. 19 is a graph showing the relationship between an Euler angle ϕ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 0^\circ, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0053] Fig. 20 is a graph showing the relationship between an Euler angle ϕ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(\phi, 90^\circ,$

0°), and a SiO₂ film is then formed thereon.

[0054] Fig. 21 is a graph showing the relationship between an Euler angle ϕ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 0°), and a SiO₂ film is then formed thereon.

[0055] Fig. 22 is a graph showing the relationship between an Euler angle ϕ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 0°), and a SiO₂ film is then formed thereon.

[0056] Fig. 23 is a graph showing the relationship between an Euler angle ϕ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 0°), and a SiO₂ film is then formed thereon.

[0057] Fig. 24 is a graph showing the relationship between an Euler angle ϕ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 0°), and a SiO₂ film is then formed thereon.

[0058] Fig. 25 is a graph showing the relationship between an Euler angle ϕ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 90°), and a SiO₂ film is then formed thereon.

[0059] Fig. 26 is a graph showing the relationship between an Euler angle ϕ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 90°), and a SiO₂ film is then formed thereon.

[0060] Fig. 27 is a graph showing the relationship between an

Euler angle ϕ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 90°), and a SiO₂ film is then formed thereon.

[0061] Fig. 28 is a graph showing the relationship between an Euler angle ϕ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 90°), and a SiO₂ film is then formed thereon.

[0062] Fig. 29 is a graph showing the relationship between an Euler angle ϕ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (ϕ , 90°, 90°), and a SiO₂ film is then formed thereon.

[0063] Fig. 30 is a graph showing the relationship between an Euler angle θ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (0°, θ , 0°), and a SiO₂ film is then formed thereon.

[0064] Fig. 31 is a graph showing the relationship between an Euler angle θ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (0°, θ , 0°), and a SiO₂ film is then formed thereon.

[0065] Fig. 32 is a graph showing the relationship between an Euler angle θ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO₃ substrate of (0°, θ , 0°), and a SiO₂ film is then formed thereon.

[0066] Fig. 33 is a graph showing the relationship between an Euler angle θ and the temperature coefficient of frequency TCF in

the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, \theta, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0067] Fig. 34 is a graph showing the relationship between an Euler angle θ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, \theta, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0068] Fig. 35 is a graph showing the relationship between an Euler angle θ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0069] Fig. 36 is a graph showing the relationship between an Euler angle θ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0070] Fig. 37 is a graph showing the relationship between an Euler angle θ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0071] Fig. 38 is a graph showing the relationship between an Euler angle θ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0072] Fig. 39 is a graph showing the relationship between an Euler angle θ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0073] Fig. 40 is a graph showing the relationship between an Euler angle θ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0074] Fig. 41 is a graph showing the relationship between an Euler angle θ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0075] Fig. 42 is a graph showing the relationship between an Euler angle θ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0076] Fig. 43 is a graph showing the relationship between an Euler angle θ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0077] Fig. 44 is a graph showing the relationship between an Euler angle θ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 0^\circ)$, and a SiO_2 film is then formed thereon.

[0078] Fig. 45 is a graph showing the relationship between an Euler angle θ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0079] Fig. 46 is a graph showing the relationship between an Euler angle θ and the electromechanical coefficient k^2 in the

structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0080] Fig. 47 is a graph showing the relationship between an Euler angle θ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0081] Fig. 48 is a graph showing the relationship between an Euler angle θ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0082] Fig. 49 is a graph showing the relationship between an Euler angle θ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, \theta, 90^\circ)$, and a SiO_2 film is then formed thereon.

[0083] Fig. 50 is a graph showing the relationship between an Euler angle ψ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0084] Fig. 51 is a graph showing the relationship between an Euler angle ψ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0085] Fig. 52 is a graph showing the relationship between an Euler angle ψ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 0^\circ,$

ψ), and a SiO_2 film is then formed thereon.

[0086] Fig. 53 is a graph showing the relationship between an Euler angle ψ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0087] Fig. 54 is a graph showing the relationship between an Euler angle ψ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0088] Fig. 55 is a graph showing the relationship between an Euler angle ψ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0089] Fig. 56 is a graph showing the relationship between an Euler angle ψ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0090] Fig. 57 is a graph showing the relationship between an Euler angle ψ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0091] Fig. 58 is a graph showing the relationship between an Euler angle ψ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0092] Fig. 59 is a graph showing the relationship between an

Euler angle ψ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(0^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0093] Fig. 60 is a graph showing the relationship between an Euler angle ψ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0094] Fig. 61 is a graph showing the relationship between an Euler angle ψ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0095] Fig. 62 is a graph showing the relationship between an Euler angle ψ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0096] Fig. 63 is a graph showing the relationship between an Euler angle ψ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0097] Fig. 64 is a graph showing the relationship between an Euler angle ψ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 0^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0098] Fig. 65 is a graph showing the relationship between an Euler angle ψ and the acoustic velocity V in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 90^\circ,$

ψ), and a SiO_2 film is then formed thereon.

[0099] Fig. 66 is a graph showing the relationship between an Euler angle ψ and the electromechanical coefficient k^2 in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0100] Fig. 67 is a graph showing the relationship between an Euler angle ψ and the propagation loss α in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0101] Fig. 68 is a graph showing the relationship between an Euler angle ψ and the temperature coefficient of frequency TCF in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0102] Fig. 69 is a graph showing the relationship between an Euler angle ψ and the power flow angle PFA in the structure in which Au electrodes are formed on a LiNbO_3 substrate of $(90^\circ, 90^\circ, \psi)$, and a SiO_2 film is then formed thereon.

[0103] Fig. 70 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ag.

[0104] Fig. 71 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ag.

[0105] Fig. 72 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ag.

[0106] Fig. 73 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ag.

[0107] Fig. 74 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Al.

[0108] Fig. 75 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Al.

[0109] Fig. 76 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Al.

[0110] Fig. 77 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Al.

[0111] Fig. 78 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave

in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Au.

[0112] Fig. 79 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Au.

[0113] Fig. 80 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Au.

[0114] Fig. 81 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Au.

[0115] Fig. 82 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cr.

[0116] Fig. 83 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cr.

[0117] Fig. 84 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cr.

[0118] Fig. 85 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cr.

[0119] Fig. 86 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cu.

[0120] Fig. 87 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cu.

[0121] Fig. 88 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cu.

[0122] Fig. 89 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Cu.

[0123] Fig. 90 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Fe.

[0124] Fig. 91 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley

wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Fe.

[0125] Fig. 92 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Fe.

[0126] Fig. 93 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Fe.

[0127] Fig. 94 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Mo.

[0128] Fig. 95 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Mo.

[0129] Fig. 96 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Mo.

[0130] Fig. 97 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Mo.

[0131] Fig. 98 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ni.

[0132] Fig. 99 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ni.

[0133] Fig. 100 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ni.

[0134] Fig. 101 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ta.

[0135] Fig. 102 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ta.

[0136] Fig. 103 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ta.

[0137] Fig. 104 is a graph showing the relationship between

the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ta.

[0138] Fig. 105 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from W.

[0139] Fig. 106 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from W.

[0140] Fig. 107 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from W.

[0141] Fig. 108 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from W.

[0142] Fig. 109 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ti.

[0143] Fig. 110 is a graph showing the relationship between

the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ti.

[0144] Fig. 111 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ti.

[0145] Fig. 112 is a graph showing the relationship between the electrode thickness and the temperature coefficient of frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Ti.

[0146] Fig. 113 is a graph showing the relationship between the electrode thickness and the acoustic velocity of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Pt.

[0147] Fig. 114 is a graph showing the relationship between the electrode thickness and the propagation loss α of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Pt.

[0148] Fig. 115 is a graph showing the relationship between the electrode thickness and the electromechanical coefficient k^2 of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Pt.

[0149] Fig. 116 is a graph showing the relationship between the electrode thickness and the temperature coefficient of

frequency TCF of a Stoneley wave in a boundary acoustic wave device formed in Example 3 in which the electrodes are formed from Pt.

[0150] Fig. 117 is a graph showing the relationship between the density of electrodes and the thickness thereof at which the propagation loss α of a Stoneley wave is 0, the relationship being obtained when boundary acoustic wave devices are formed by variously changing the density of the electrodes in Example 3.

[0151] Fig. 118 is a graph showing the relationship between the acoustic velocity and an Euler angle ϕ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles (ϕ , 30° , 0°).

[0152] Fig. 119 is a graph showing the relationship between the temperature coefficient of frequency TCF and an Euler angle ϕ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles (ϕ , 30° , 0°).

[0153] Fig. 120 is a graph showing the relationship between the electromechanical coefficient k^2 and an Euler angle ϕ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles (ϕ , 30° , 0°).

[0154] Fig. 121 is a graph showing the relationship between the power flow angle PFA and an Euler angle ϕ in a boundary acoustic wave device formed in Example 4 in which Au electrodes

and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles $(\phi, 30^\circ, 0^\circ)$.

[0155] Fig. 122 is a graph showing the relationship between the propagation loss α and an Euler angle ϕ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles $(\phi, 30^\circ, 0^\circ)$.

[0156] Fig. 123 is a graph showing the relationship between the acoustic velocity and an Euler angle ψ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles $(0^\circ, 30^\circ, \psi)$.

[0157] Fig. 124 is a graph showing the relationship between the temperature coefficient of frequency TCF and an Euler angle ψ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles $(0^\circ, 30^\circ, \psi)$.

[0158] Fig. 125 is a graph showing the relationship between the electromechanical coefficient k^2 and an Euler angle ψ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles $(0^\circ, 30^\circ, \psi)$.

[0159] Fig. 126 is a graph showing the relationship between the power flow angle PFA and an Euler angle ψ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles

(0° , 30° , ψ).

[0160] Fig. 127 is a graph showing the relationship between the propagation loss α and an Euler angle ψ in a boundary acoustic wave device formed in Example 4 in which Au electrodes and a SiO_2 film are formed on a LiNbO_3 substrate of Euler angles (0° , 30° , ψ).

DETAILED DESCRIPTION OF PREFERRED EMBODIMENTS

[0161] Hereinafter, with reference to the figures, particular examples of preferred embodiments of the present invention will be described so as to facilitate understanding of the present invention.

[0162] In order to enable a boundary acoustic wave to propagate between two solid layers, energy of the boundary acoustic wave must be concentrated between the solid layers.

[0163] In general, when a high acoustic velocity region and a low acoustic velocity region are present, a wave is concentrated on the low acoustic velocity region and propagates therein. Accordingly, the inventor of the present invention discovered that the condition in which energy is concentrated between two solid layers can be satisfied when the acoustic velocity of a boundary acoustic wave propagating between the solid layers is decreased by increasing the thickness of electrodes made of a metal material, such as Au or Cu, which has a high density and a low acoustic velocity as an electrode material provided between the two solid layers, and as a result, the present invention was

developed.

[0164] Heretofore, it has been known that three types of bulk waves, that is, a longitudinal wave, a fast transverse wave, and a slow transverse wave are present, and that they are called a P wave, an SH wave, and an SV wave, respectively. Whether the SH wave or the SV wave becomes a slow transverse wave is determined by the anisotropic properties of a base material. Among the above three types of bulk waves, a bulk wave having the lowest acoustic velocity is a slow transverse wave. When the solid substance is an isotropic substance such as SiO_2 , since only one type of transverse wave propagates therethrough, this transverse wave is a slow transverse wave.

[0165] On the other hand, in a boundary acoustic wave propagating through an anisotropic base material, such as a piezoelectric substrate, in most cases, three displacement components of the P wave, SH wave, and SV wave propagate while being coupled with each other, and the type of boundary acoustic wave is determined by the primary component. For example, the above Stoneley wave is a boundary acoustic wave primarily composed of the P wave and the SV wave, and the SH type boundary acoustic wave is a boundary acoustic wave primarily composed of the SH component. In addition, depending on the conditions, the SH wave component and the P wave or the SV wave component may propagate in some cases without being coupled with each other.

[0166] In the boundary acoustic wave, since the three displacement components described above propagate while being

coupled with each other, for example, in a boundary acoustic wave having an acoustic velocity greater than that of the SH wave, the SH component and the SV component leak, and in a boundary acoustic wave having an acoustic velocity greater than that of the SV wave, the SV component leaks. This leaky-wave component causes propagation loss of the boundary acoustic wave.

[0167] Accordingly, when the acoustic velocity of the Stoneley wave is decreased to less than the acoustic velocities of two slow transverse waves of the above two solid layers, energy of the Stoneley wave is concentrated around electrodes disposed between the two solid layers, and a Stoneley wave having a large electromechanical coefficient k^2 is propagated, such that conditions are obtained in which the propagation loss is zero. Since an electrode material having a large density has a slow acoustic velocity, when the acoustic velocity of the Stoneley wave is decreased, an electrode material having a large density is preferably used. The present invention was made based on this understanding.

[0168] In addition, when at least one of the solid layers is made of a piezoelectric substance, and a dielectric substance including a piezoelectric substance is used as the other solid layer, the Stoneley wave is excited by the electrodes disposed between the solid layers. The electrodes may include comb electrodes or interdigital electrodes (interdigital transducer, IDT) as disclosed by Mikio SHIBAYAMA in "Engineering of Surface Acoustic Wave" November 15, 1983, pp. 56 to 58, published by The

Institute of Electronics and Communication Engineers.

[0169] Fig. 1 is a schematic front cross-sectional view of a boundary acoustic wave device of one preferred embodiment according to the present invention, and Fig. 2 is a plan view of an electrode structure of the boundary acoustic wave device. In a boundary acoustic wave device 1, a dielectric substance 3 is laminated on a plate-shaped piezoelectric substance 2. At a boundary between the piezoelectric substance 2 and the dielectric substance 3, electrodes defining an IDT 4 and reflectors 5 and 6 are provided. The reflectors 5 and 6 are disposed on both sides of the IDT 4 in the propagation direction of a surface acoustic wave, and thus, in this preferred embodiment, a boundary acoustic wave resonator is formed.

[0170] One of the unique features of the boundary acoustic wave device of this preferred embodiment is that the IDT 4 and the reflectors 5 and 6 have a large thickness such that the acoustic velocity of a Stoneley wave is decreased to less than that of a slow transverse wave propagating through the dielectric substance 3 and that of a slow transverse wave propagating through the piezoelectric substance 2.

[0171] In this preferred embodiment, the thickness of the electrode is increased so as to decrease the acoustic velocity of the Stoneley wave to less than that of each of the slow transverse waves propagating through the piezoelectric substance 2 and the dielectric substance 3. Thus, the energy of the Stoneley wave is concentrated on the boundary between the

piezoelectric substance 2 and the dielectric substance 3.

Accordingly, a Stoneley wave having a large electromechanical coefficient k^2 is propagated with a low propagation loss.

[0172] In addition to the increase in thickness of the electrodes so as to enable the Stoneley wave to propagate, in the present invention, when the acoustic velocity of the Stoneley wave is decreased to less than that of each of the slow transverse waves propagating through the piezoelectric substance 2 and the dielectric substance 3 by controlling the duty ratio of strips defining the electrodes as described later, the Stoneley wave is concentrated on the boundary between the two substances described above and is then be propagated.

[0173] Incidentally, the duty ratio of strips is a value represented by L/P where L is the width of the strip and P is a distance from the center of a space between adjacent strips to the center of a next space adjacent to the above space.

[0174] The structure shown in Fig. 1 is a simple structure in which the IDT 4 and the reflectors 5 and 6 are disposed as the electrodes between the piezoelectric substance 2 and the dielectric substance 3. With the structure described above, boundary acoustic wave devices using a Stoneley wave can be formed using a great number of materials. For example, in the structure disclosed in the non-patent document 2, which is composed of SiO_2 /IDT electrode/ 128° rotated Y plate X-propagation LiNbO_3 , the Stoneley wave was not confirmed. However, although the Stoneley wave may not be formed when the electrode thickness

is small, the Stoneley wave may be allowed to exist when the electrode thickness is increased. Hereinafter, with reference to particular examples, the present invention will be described in detail.

Example 1

[0175] A 128° rotated Y plate X-propagation LiNbO_3 substrate, that is, having Euler angles $(0^\circ, 38^\circ, 0^\circ)$ was prepared as the piezoelectric substance 2. On this LiNbO_3 substrate, as an adhesion layer, a NiCr film was formed by an evaporation method. Next, on this adhesion layer, a Au film was formed by an evaporation method, followed by patterning using a lift-off method, such that the IDT 4 and the reflectors 5 and 6 were formed. In addition, a SiO_2 film was formed by an RF magnetron sputtering method at a film-forming temperature of 200°C so as to cover the IDT 4 and the reflectors 5 and 6.

[0176] The number of electrode finger pairs of the IDT 4 and the number of electrode fingers of each reflector were set to 50.5 and 51, respectively.

[0177] In addition, the crossing width of the electrode fingers of the IDT 4 was set to 30λ . On the other hand, an aperture length A (see Fig. 2) of the reflectors 5 and 6 was set to 30.5λ . In this example, λ was a placement period of the electrode fingers of the IDT 4 and the reflectors 5 and 6. In addition, the duty ratios of the IDT 4 and the reflectors 5 and 6 were each set to 0.5.

[0178] As described above, while the NiCr film, the Au film and the SiO₂ film were variously formed as shown in the following Table 2, one-port boundary acoustic wave devices 1 were formed.

Table 2

図番	Au(λ)	SiO ₂ (λ)	NiCr(λ)
A 1	0.075	4.5	0.005
A 2	0.060	3.6	0.004
A 3	0.056	3.3	0.004
A 4	0.050	3.0	0.003
A 5	0.043	2.6	0.003
A 6	0.038	2.3	0.003
A 7	0.030	1.8	0.002

[0179] The impedance-frequency characteristics of each of the boundary acoustic wave devices A1 to A7 shown in Table 2, which were formed as described above, were measured. The results are shown in Figs. 3 to 9. The impedance on the vertical axis of Figs. 3 to 9 is the value represented by

$$20 \times \log_{10} |Z| \text{ [dB] (Equation 1)}$$

[0180] In addition, in Figs. 3 to 9, the horizontal axis represents the frequency normalized by a resonant frequency of a response of the Stoneley wave.

[0181] As shown in Figs. 3 to 9, in the boundary acoustic wave devices A1 to A7 shown in the above Table 2, a ratio Z_a/Z_r between an impedance Z_a at an antiresonant point and an impedance Z_r at a resonant point is in the range of about 50 dB to about 60 dB, and thus, superior resonant characteristics are obtained.

[0182] On the other hand, when a boundary acoustic wave device was formed in a manner similar to that for the above-described

boundary acoustic wave devices except that Al was used as the electrode material, a response of a high order spurious mode was only confirmed, and no response of the Stoneley wave could be confirmed. This result coincides with the experimental result of the above-described non-patent document 2. In this example, in order to confirm the response of the Stoneley wave, a damping material was adhered to a chip surface, and the presence of attenuation was measured.

[0183] As is apparent from the experimental results, when electrodes primarily composed of Au, which is heavier than Al, are used, and the thickness of the electrodes is set to at least about 0.03λ , the response of the Stoneley wave in the $\text{SiO}_2/\text{LiNbO}_3$ substrate is confirmed, which could not be realized in the past, and superior resonant characteristics are obtained.

[0184] In addition, where a rotated Y plate X-propagation LiTaO_3 substrate or a quartz substrate was used as the piezoelectric substance 2, when the thickness of the Au film was set to at least about 0.03λ , it was confirmed that the Stoneley wave can be propagated. Furthermore, with other piezoelectric substrates, when the thickness of the Au film was set to at least about 0.03λ , it was confirmed that the Stoneley wave can be propagated as is the case described above.

[0185] In Figs. 3 to 9, the normalized resonant frequency of the response of the Stoneley wave is about 1.0. The response at a lower frequency side than that of the Stoneley wave was a spurious response caused by the SH boundary acoustic wave, and a

response at a higher frequency side than that of the Stoneley wave was a response by the high order spurious mode.

[0186] The response of the high order spurious mode is suppressed by a method, for example, described in Japanese Patent Application No. 2003-114592.

Example 2

[0187] In Example 1, the spurious response was generated by the SH type boundary acoustic wave at a lower frequency side than that of the response by the Stoneley wave. In Example 2, this spurious response was intended to be suppressed.

[0188] That is, in order to suppress the spurious response by the SH boundary acoustic wave, the relationships of the Euler angle of a LiNbO_3 substrate with the acoustic velocity V , the electromechanical coefficient k^2 , the propagation loss α , the temperature coefficient of frequency TCF, and the power flow angle (PFA) of the Stoneley wave and the SH type boundary acoustic wave were obtained. The calculation was performed based on a method disclosed in "A Method For Estimating Optimal Cuts and Propagation Directions for Excitation and Propagation Directions for Excitation of Piezoelectric Surface Waves" (J. J. Campbell and W. R. Jones, IEEE Trans. Sonics and Ultrasonics, Vol. SU-15, No. 4 (October 1968) pp. 209 to 217). In the case of a free boundary, the acoustic velocity and the propagation loss were obtained based on the assumption that the displacements, the potentials, the normal line components of an electric flux

density, and the stresses in the up and down direction at respective boundaries between SiO₂ and Au and between Au and LiNbO₃ were continuous, the thickness of SiO₂ and that of LiNbO₃ were infinite, and the relative dielectric constant of Au was 1. In addition, in the case of a short-circuit boundary, the potentials at the respective boundaries between SiO₂ and Au and between Au and LiNbO₃ were assumed to be zero. In addition, the electromechanical coefficient k^2 was obtained by the following equation [1]. In this equation, V_f indicates the acoustic velocity of the free boundary.

$$k^2 = 2 \times |V_f - V| / V_f \quad \dots [1]$$

[0189] The temperature coefficient of frequency TCF was obtained from phase velocities V at 20°C, 25°C, and 30°C using the following equation [2].

$$TCF = V^{-1}(25^\circ\text{C}) \times [(V(30^\circ\text{C}) - V(20^\circ\text{C}) / 10^\circ\text{C})] - dS \quad \dots [2]$$

[0190] In the above equation, dS indicates the coefficient of linear thermal expansion of the LiNbO₃ substrate in the propagation direction of the boundary acoustic wave.

[0191] In addition, the power flow angle PFA at optional Euler angles (ϕ , θ , ψ) was obtained from phase velocities V at angles of $\psi - 0.5^\circ$, ψ , and $\psi + 0.5^\circ$ using the following equation [3].

$$PFA = \tan^{-1} [V^{-1}(\psi) \times (V(\psi + 0.5^\circ) - V(\psi - 0.5^\circ))] \quad \dots [3]$$

[0192] The structure used in this example was a structure in which Au electrodes were formed on a LiNbO₃ substrate and a SiO₂ film was then formed thereon. The thickness of the Au electrodes was set to 0.07λ , the Euler angles were (0° , 0° , ψ), (0° , 90° , ψ),

$(90^\circ, 0^\circ, \psi)$, $(90^\circ, 90^\circ, \psi)$, $(0^\circ, \theta, 0^\circ)$, $(0^\circ, \theta, 90^\circ)$, $(90^\circ, \theta, 0^\circ)$, $(90^\circ, \theta, 90^\circ)$, $(\phi, 0^\circ, 0^\circ)$, $(\phi, 0^\circ, 90^\circ)$, $(\phi, 90^\circ, 0^\circ)$, and $(\phi, 90^\circ, 90^\circ)$, and ϕ, θ, ψ were each within 0° to 180° .

[0193] The results are shown in Figs. 10 to 69.

[0194] In Figs. 10 to 69, a value with a small letter m as a subscript indicates a calculated value at the short-circuit boundary at which the metal film is disposed between the SiO_2 film and the LiNbO_3 substrate, and a value with a small letter f as a subscript indicates a calculated value at the free boundary obtained based on the assumption that the relative dielectric constant of the metal film is 1. A value with U2 as a prefix is a calculated value of the SH boundary acoustic wave, and a value with U3 is a calculated value of the Stoneley wave.

[0195] When the Stoneley wave is used, the SH boundary acoustic wave causes a spurious response, and ripples are generated in a pass band, or the amount of out-of-band attenuation is degraded. When the electromechanical coefficient k^2 of the SH boundary acoustic wave is about 2% or less, the degradation in properties caused by spurious responses of the SH boundary acoustic wave is reduced, and the boundary acoustic wave device using a Stoneley wave can be used in a relatively wide application. In addition, when the electromechanical coefficient k^2 of the SH boundary acoustic wave is about 1% or less, the boundary acoustic wave device using a Stoneley wave can be provided which can be used in a wider application. More preferably, when the electromechanical coefficient k^2 of the SH

boundary acoustic wave is about 0.1% or less, since the influence of spurious responses of the SH boundary acoustic wave is not substantially observed, the boundary acoustic wave device using a Stoneley wave according to a preferred embodiment of the present invention can be used for a filter which is required to have a large attenuation amount and for a highly precise resonator in which even a slight resonant spurious response is not allowed.

[0196] In Figs. 10 to 69, Euler angles at which the electromechanical coefficient k^2 of the SH boundary acoustic wave is about 2% or less are preferably in the ranges of (0°, 0°, 0°) to (0°, 0°, 180°), (0°, 90°, 49°) to (0°, 90°, 131°), (90°, 0°, 0°) to (90°, 0°, 180°), (90°, 90°, 48°) to (0°, 90°, 131°), (0°, -32°, 0°) to (0°, 47°, 0°), (0°, 0°, 90°) to (0°, 180°, 90°), (90°, -39°, 0°) to (90°, 39°, 0°), (90°, 0°, 90°) to (90°, 180°, 90°), (0°, 0°, 0°) to (180°, 0°, 0°), (0°, 0°, 90°) to (180°, 0°, 90°), and (0°, 90°, 90°) to (180°, 90°, 90°). Euler angles at which the electromechanical coefficient k^2 of the SH boundary acoustic wave is about 1% or less are preferably in the ranges of (0°, 0°, 12.5°) to (0°, 0°, 47.5°), (0°, 0°, 62.5°) to (0°, 0°, 107.5°), (0°, 0°, 132.5°) to (0°, 0°, 167.5°), (0°, 90°, 56°) to (0°, 90°, 125°), (90°, 0°, -18°) to (90°, 0°, 18°), (90°, 0°, 42°) to (90°, 0°, 78°), (90°, 0°, 102°) to (90°, 0°, 138°), (90°, 0°, 162°) to (90°, 0°, 180°), (90°, 90°, 57°) to (90°, 90°, 127°), (0°, 13°, 0°) to (0°, 42°, 0°), (0°, 0°, 90°) to (0°, 180°, 90°), (90°, -32°, 0°) to (90°, 32°, 0°), (90°, 70°, 90°) to (90°, 110°, 90°), (12°, 0°, 0°) to (48°, 0°, 0°), (72°, 0°, 0°) to (107°, 0°, 0°), (132°, 0°, 0°) to (167°, 0°, 0°),

0°), (-18°, 0°, 90°) to (18°, 0°, 90°), (42°, 0°, 90°) to (78°, 0°, 90°), (102°, 0°, 90°) to (138°, 0°, 90°), and (0°, 90°, 90°) to (180°, 90°, 90°). Euler angles at which the electromechanical coefficient k^2 of the SH boundary acoustic wave is about 0.1% or less are preferably in the ranges of (0°, 0°, 26°) to (0°, 0°, 36°), (0°, 0°, 86°) to (0°, 0°, 96°), (0°, 0°, 146°) to (0°, 0°, 156°), (0°, 90°, 80°) to (0°, 90°, 111°), (90°, 90°, 110°) to (90°, 00°, 119°), (0°, 26°, 0°) to (0°, 34°, 0°), (0°, 0°, 90°) to (0°, 180°, 90°), (90°, -14°, 0°) to (90°, 14°, 0°), (26°, 0°, 0°) to (34°, 0°, 0°), (86°, 0°, 0°) to (94°, 0°, 0°), (146°, 0°, 0°) to (154°, 0°, 0°), (-6°, 0°, 90°) to (6°, 0°, 90°), (54°, 0°, 90°) to (66°, 0°, 90°), (114°, 0°, 90°) to (126°, 0°, 90°), (-7°, 90°, 90°) to (7°, 90°, 90°), (53°, 90°, 90°) to (67°, 90°, 90°), and (113°, 90°, 90°) to (127°, 90°, 90°).

[0197] When LiNbO₃ substrates in the above-noted Euler angle ranges are used, a boundary acoustic wave device using a Stoneley wave can also be provided which has a small spurious response or which will generate no spurious response.

[0198] Under all the conditions of the calculation results shown in Figs. 10 to 69, propagation losses U3- α m and U3- α f of the Stoneley wave were zero, and hence superior propagation properties are obtained.

[0199] In addition, the acoustic velocity U3-Vm of the Stoneley wave concentrates at approximately 3,000 m/sec to approximately 3,400 m/sec, and thus, the change caused by the cut angle is small.

[0200] Accordingly, even when the cut angle is changed, an electrode thickness H at a propagation loss of zero can be obtained by equation (4) which will be described later.

[0201] In addition, the temperature coefficient of frequency U3-TCFm of the Stoneley wave is concentrated at approximately -30 to -40 ppm/°C, and the change caused by the cut angle is insignificant. Accordingly, even when the cut angle is changed, an electrode thickness H at which the temperature coefficient of frequency TCF is decreased can be determined by the equation (4).

Example 3

[0202] A 120° rotated Y plate X-propagation LiNbO₃ substrate, that is, having Euler angles (0°, 30°, 0°), was prepared as the piezoelectric substance 2 using the calculation method described in Example 2, and taking into account easy thin film formation and a function of counteracting the TCF of LiNbO₃, a SiO₂ film was selected as the dielectric substance 3. By forming electrodes using electrode materials having various densities, boundary acoustic wave devices were formed. Subsequently, the relationships of the electrode thickness of each of the boundary acoustic wave devices thus formed with the acoustic velocity, the propagation loss α (dB/λ), the electromechanical coefficient k^2 (%), and the temperature coefficient of frequency TCF of the Stoneley wave were obtained. The results are shown in Figs. 70 to 116. It is noted that the power flow angle PFA was zero under all the conditions.

[0203] In the 120° rotated Y plate X-propagation LiNbO₃ substrate, the acoustic velocity of a longitudinal wave, that of a slow transverse wave, and that of a fast transverse wave are approximately 6,547, 4,752, and 4,031 m/sec, respectively. In addition, the acoustic velocities of a longitudinal wave and a slow transverse wave of SiO₂ are approximately 5,960 and 3,757 m/sec, respectively. According to Figs. 70 to 116, at an electrode thickness at which the acoustic velocity of the Stoneley wave is less than 3,757 m/sec, which is the lowest acoustic velocity mentioned above, the propagation loss α of the Stoneley wave is zero. That is, by merely using an electrode material having a large density, the propagation loss α of the Stoneley wave cannot be decreased to zero, and when the electrode thickness is increased so that the velocity of the Stoneley wave is decreased to less than approximately 3,757 m/sec, the propagation loss α is decreased to zero.

[0204] Thus, in various preferred embodiments of the present invention, the electrode thickness is preferably set so that the acoustic velocity of the Stoneley wave is decreased to less than the lowest acoustic velocity of those mentioned above, and accordingly, the propagation loss α of the Stoneley wave is decreased to zero.

[0205] Furthermore, in various preferred embodiments of the present invention, by using an electrode made of a material having a large density, the acoustic velocity of a transverse wave in the electrode is decreased, and as a result, the energy

of the Stoneley wave is concentrated on the electrode. Thus, electric energy applied to the electrode and electric energy of the Stoneley wave are efficiently coupled to each other, and as a result, a large electromechanical coefficient k^2 is obtained. In addition, since the energy is concentrated on the electrode, the reflection coefficient of the Stoneley wave reflected by electrode fingers forming the electrode is also increased. When the reflection coefficient of the Stoneley wave by the electrode fingers is increased, the number of electrode fingers forming a grating reflector can be decreased. As a result, the size of the boundary acoustic wave device can be reduced. Furthermore, the reflection band of the reflector can also be increased.

[0206] When the reflection of electrode fingers of the IDT 4 is not present, the frequency characteristics of the conductance of the IDT 4 are represented by the symmetric sinc function. On the other hand, when the reflection of the electrode fingers is present, the frequency characteristics of the conductance become asymmetric, and the conductance at a low frequency side of the band or at a high frequency side thereof increases. As the reflection of the electrode fingers is increased, the asymmetry of the above-described frequency characteristics is increased.

[0207] By using an IDT having internal reflection as described above, for example, when an input side IDT and an output IDT are disposed in the propagation direction of a boundary acoustic wave, and when reflectors are disposed at two sides of the region in which the above-described IDTs are arranged so as to form a

longitudinally coupled filter, a filter pass band is formed which reflects the asymmetry of the conductance characteristics. In this case, as the reflection coefficient of the electrode fingers is increased, a steep band region can be designed. As described above, when the reflection coefficient of the finger electrodes of the IDT is increased, steeper filter characteristics are easily obtained.

[0208] Fig. 117 is a graph showing the relationship between the density ρ of the electrode material and the electrode thickness H at which the propagation loss of the Stoneley wave is zero. In addition, in the following Table 3, the densities of various metals used as the electrode materials are shown.

Table 3

Material	Density (kg/m^3)
A l	2699
T i	4540
F e	7830
N i	8845
C u	8930
M o	10219
A g	10500
T a	16600
A u	19300
W	19300
P t	21400

[0209] As shown in Fig. 117, when the thickness and the electrode material are determined so as to satisfy the following equation (4), the propagation loss of the Stoneley wave is decreased to zero.

$$H[\lambda] > 1 / \{ (3 \times 10^7 \times \rho)^{-2.22} + 0.017 \} - 0.4 \} \dots \text{Equation (4)}$$

[0210] In addition, when this type of boundary acoustic wave device is manufactured, electrodes, such as an IDT, are formed on a piezoelectric substrate, such as a LiNbO_3 substrate, by a photolithographic technique including lift-off or dry etching, and on the electrodes, a dielectric film made of SiO_2 or other suitable material is formed by a thin-film forming method including sputtering, evaporation, or CVD. Thus, irregularities are generated on the upper surface of the dielectric film due to the thickness of the IDT. In addition, the dielectric film may be obliquely grown or the film quality may become non-uniform in some cases. When the irregularities, the film growth in an oblique direction, or the non-uniformity of the film quality occurs, the properties of the boundary acoustic wave device are degraded.

[0211] In order to avoid the degradation of the properties described above, the thickness of the electrode is preferably small. According to research performed by the inventors of the present invention, when the thickness H of the electrode is at least about 0.1λ , it becomes difficult to form a dielectric thin film having superior quality. In particular, when the electrode thickness is at least about 0.25λ , the aspect ratio of the electrode becomes at least 1, and it also becomes difficult to form the electrode by using an inexpensive dry etching step or lift-off step. Furthermore, the methods and apparatuses used for dielectric thin-film formation are limited, and as a result, it is difficult to form a dielectric thin film by general RF

magnetron sputtering. Therefore, the electrode thickness is preferably about 0.25λ or less, and more preferably about 0.1λ or less.

[0212] As shown in Fig. 117, when an electrode material having a density ρ of about $4,711 \text{ kg/m}^3$ or more is used, the electrode thickness H at which the propagation loss of the Stoneley wave becomes zero is decreased to about 0.25λ or less, and when an electrode material having a density ρ of about $7,316 \text{ kg/m}^3$ or more is used, the electrode thickness H at which the propagation loss of the Stoneley wave becomes zero is decreased to about 0.10λ or less. Hence, in the present invention, the density ρ of the electrode material is preferably about $4,711 \text{ kg/m}^3$ or more, and more preferably about $7,316 \text{ kg/m}^3$ or more.

[0213] In addition, as shown in Figs. 72, 76, 80, 84, 88, 92, 96, 103, 107, 111, and 115, at the electrode thickness H at which the condition shown by the above equation (4) is satisfied, the electromechanical coefficient k^2 is sufficiently large, such as about 3% to about 9.4%. Thus, at the electrode thickness H at which the above equation (4) holds, a boundary acoustic wave device having a sufficient band width is provided.

[0214] In addition, as shown in Figs. 73, 77, 81, 85, 89, 93, 97, 100, 104, 108, 112 and 116, at the electrode thickness H at which the above equation (4) is satisfied, the absolute values of TCFs of Ag, Au, Cu, Fe, Ta, W, Ti, and Pt is about 40 ppm or less. Thus, the electrode material is preferably at least one material selected from the group consisting of Ag, Au, Cu, Fe, Ta, W, Ti,

and Pt since the temperature coefficient of frequency characteristics is improved.

Example 4

[0215] Next, electrodes of Au having a thickness of about 0.06λ were formed on respective LiNbO₃ substrates with Euler angles $(\phi, 30^\circ, 0^\circ)$ and Euler angles $(0^\circ, 30^\circ, \psi)$, and SiO₂ films were formed over the respective electrodes. The relationships of the Euler angles θ and ψ with the acoustic velocities V , the electromechanical coefficients k^2 , the propagation losses α , the temperature coefficients of frequency TCF, and the power flow angles (PFA) of the SH type boundary acoustic wave and the Stoneley wave were measured. The results are shown in Figs. 118 to 122 and Figs. 119 to 127. In Figs. 118 to 127, U2 shows the results of the SH boundary acoustic wave, and U3 show the results of the Stoneley wave. In the entire ranges of Euler angles $(0^\circ$ to $90^\circ, 30^\circ, 0^\circ)$ and $(0^\circ, 30^\circ, 0^\circ$ to $90^\circ)$, the propagation loss α was 0 dB/ λ .

[0216] As shown in Figs. 118 to 122, the electromechanical coefficient k^2 of the SH boundary acoustic wave is small, such as about 0.3% or less, in the range of ϕ of about 0° to about 15° , and the electromechanical coefficient k^2 of the SH boundary acoustic wave is approximately 0% at ϕ of approximately 0° . Thus, the spurious response caused by the SH boundary acoustic wave is very small. In addition, in the range of ϕ of about 0° to about 90° , TCF is superior, such as in the range of about -37 ppm/ $^\circ\text{C}$ to

about -33 ppm/°C, and the electromechanical coefficient k^2 of the Stoneley wave is sufficiently large, such as about 3.5% to about 5%. Thus, a boundary acoustic wave filter is provided which is preferably used as an RF filter in the narrow to the medium bands. In addition, in the range of ϕ of about 0° to about 90°, the power flow angle PFA of the Stoneley wave was small, such as about $\pm 1.5^\circ$ or less.

[0217] As shown in Figs. 123 to 127, the electromechanical coefficient k^2 of the SH boundary acoustic wave is small, such as about 0.3% or less, in the range of ψ of about 0° to about 14°, and the electromechanical coefficient k^2 of the SH boundary acoustic wave becomes approximately 0% at ψ of 0°. Thus, the spurious response caused by the SH boundary acoustic wave is very small. In addition, in the range of ψ of 0° to 90°, TCF is superior, such as in the range of about -36 ppm/°C to about -33 ppm/°C. In addition, in the range of ψ of about 0° to about 45°, the electromechanical coefficient k^2 of the Stoneley wave is sufficiently large, such as about 3.5% to about 5%, and thus, a boundary acoustic wave filter is provided which is preferably used as an RF filter in the narrow to the medium bands. In addition, in the range of ψ of about 0° to about 90°, the power flow angle of the Stoneley wave was small, such as about $\pm 1.7^\circ$ or less.

[0218] In preferred embodiments of the present invention, the thicknesses of the dielectric substance and the piezoelectric substance are not necessarily infinite as that of the model which

was used for the calculation and may be enough when energy of a boundary acoustic wave is confined to near the electrodes provided at the boundary, that is, for example, a thickness of about 1λ or more may be enough.

[0219] In addition, according to preferred embodiments of the present invention, the piezoelectric substance described above may be a piezoelectric film formed on a dielectric substance.

[0220] Furthermore, in the boundary acoustic wave device according to preferred embodiments of the present invention, in order to increase the strength or to prevent entry of corrosive gases, a protective layer may be formed outside of the boundary acoustic wave device in the lamination direction of the dielectric substance-electrodes-piezoelectric substance laminate structure. In this case, the boundary acoustic wave device of various preferred embodiments of the present invention may be sealed with a packaging material in some cases.

[0221] In addition, the protective layer described above may be formed from an insulating material such as titanium oxide, aluminum nitride, or aluminum oxide, a metal film such as Au, Al, or W, or a resin such as a urethane, epoxy, or silicone resin.

[0222] Besides Au, Ag, Cu, and Al, the electrodes may be formed from a conductive film made of a metal, such as Fe, Ni, W, Ta, Pt, Mo, Cr, Ti, ZnO, or ITO. In addition, in order to enhance the adhesion and electric power resistance, on an electrode layer formed from Au, Ag, Cu, Al, or an alloy thereof, a second electrode layer formed from another metal material, such

as Ti, Cr, or a NiCr alloy may be laminated. In this case, the second electrode layer may be provided between the first electrode layer and the piezoelectric substance, between the first electrode layer and dielectric substance, or at both locations mentioned above.

[0223] Furthermore, in preferred embodiments of the present invention, the electrode may include a sheet-shaped electrode film which defines a waveguide or a bus bar, an IDT or comb-shaped electrode exciting a boundary acoustic wave, or a reflector reflecting a boundary acoustic wave.

[0224] In addition, in the specification of the present invention, as the Euler angles (ϕ , θ , ψ) representing the cut surface of a substrate and the propagation direction of a boundary acoustic wave, the right-hand Euler angle system is used which is disclosed in "Acoustic Wave Device Technology Handbook" (edited by Acoustic Wave Device Technology 150th Committee of the Japan Society for the Promotion of Science, first print/first edition issued on Nov. 30, 1991, p. 549). That is, with respect to crystal axes X, Y, and Z of LN, an Xa axis is obtained by ϕ rotation of the X axis about the Z axis in an anticlockwise direction. Next, a Z' axis is obtained by θ rotation of the Z axis about the Xa axis in an anticlockwise direction. A plane including the Xa axis and having the Z' axis as the normal line is set as the cut surface of a substrate. In addition, the direction of an X' axis obtained by ψ rotation of the Xa axis about the Z' axis in an anticlockwise direction is set as the

propagation direction of a boundary acoustic wave.

[0225] In addition, as for the crystal axes X, Y, and Z of LiNbO_3 represented as the initial values of Euler angles, the Z axis is set parallel to the c-axis, the X axis is set parallel to any one of the three equivalent a-axes in three different directions, and the Y axis is set parallel to the normal line of a plane including the X axis and the Z axis.

[0226] In addition, Euler angles equivalent to the Euler angles (ϕ, θ, ψ) of LiNbO_3 of the present invention in terms of crystallography may be used. For example, according to "SAW Propagation Characteristics on LiTaO_3 With Arbitrary Cut", Vol. 36, No. 3, 1980, pp. 140 to 145, since LiNbO_3 is a crystal belonging to the trigonal 3 m point group, the following equation (A) is satisfied.

$$\begin{aligned} F(\phi, \theta, \psi) &= F(60^\circ - \phi, -\theta, \psi) \\ &= F(60^\circ + \phi, -\theta, 180^\circ - \psi) \\ &= F(\phi, 180^\circ + \theta, 180^\circ - \psi) \\ &= F(\phi, \theta, 180^\circ + \psi) \dots \text{Equation (A)} \end{aligned}$$

[0227] In the above equation, F is an optional boundary acoustic-wave property such as the electromechanical coefficient k^2 , propagation loss, TCF, PFA, or a natural unidirectional property. As for PFA and natural unidirectional property, for example, when the propagation direction is reversed, although a plus or a minus sign indicating the direction is changed, the absolute value of the property is not changed, and thus, it is assumed that they are substantially equivalent to each other. In

addition, although the above-described document relates to the surface acoustic wave, even when the boundary acoustic wave is discussed, the symmetry of the crystal may also be dealt with in the same manner as disclosed in the above-described document. For example, propagation properties of a boundary acoustic wave at Euler angles $(30^\circ, \theta, \psi)$ are equivalent to those at Euler angles $(90^\circ, 180^\circ - \theta, 180^\circ - \psi)$. In addition, for example, propagation properties of a boundary acoustic wave at Euler angles $(30^\circ, 90^\circ, 45^\circ)$ are equivalent to those at Euler angles shown in Table 4 below.

[0228] In addition, the material constant of the electrode used for calculation in preferred embodiments of the present invention is the value of a polycrystalline substance. However, even in a crystal substance such as an epitaxial film, since the crystal orientation dependence of a substrate dominantly influences the boundary acoustic wave properties as compared to that of the film itself, in the case of the equivalent Euler angles represented by the equation (A), equivalent boundary acoustic wave propagation properties which may not cause any practical problems can be obtained.

Table 4

ϕ (°)	θ (°)	ψ (°)
30	90	225
30	270	135
30	270	315
90	90	135
90	90	315
90	270	45
90	270	225
150	90	45
150	90	225
150	270	135
150	270	315
210	90	135
210	90	315
210	270	45
210	270	225
270	90	45
270	90	225
270	270	135
270	270	315
330	90	135
330	90	315
330	270	45
330	270	225

[0229] While preferred embodiments of the present invention have been described above, it is to be understood that variations and modifications will be apparent to those skilled in the art

without departing the scope and spirit of the present invention.
The scope of the present invention, therefore, is to be
determined solely by the following claims.